Attorney Docket No.: 01CON272P

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APR 1 5 2004

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In re Application of:

Fazelpour, Siamak

Serial No.: 10/025,438

Filed: December 19, 2001

For: Method for Integrating Passives On-Die

Utilizing Under Bump Metal and

Related Structure

Art Unit: 2812

Examiner: Nguyen, Ha T.

AMENDMENT AND RESPONSE TO NON-FINAL OFFICE ACTION

Honorable Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir/Madam:

This is in response to the Non-Final Office Action dated November 24, 2003 in the above-referenced patent application. Please enter and consider the following amendments and remarks.